

Title (en)

SILYLAMINE COMPOUND AND LATENT CURING AGENT COMPRISING SAID SILYLAMINE COMPOUND

Title (de)

SILYLAMINVERBINDUNG UND DIESE SILYLAMINVERBINDUNG ENTHALTENDES LATENTES HÄRTUNGSMITTEL

Title (fr)

COMPOSÉ SILYLAMINE, ET AGENT DE DURCISSEMENT LATENT CONTENANT CELUI-CI

Publication

EP 3875461 A1 20210908 (EN)

Application

EP 19879714 A 20191031

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Abstract (en)

An object of the present invention is to provide a compound suitable for use as a latent curing agent, which does not produce an aldehyde compound when caused to react with an isocyanate compound. The present invention provides, as the compound, a silylamine compound represented by the following formula (1): in the formula (1), R¹ to R¹² each independently represent an alkyl group having 1 to 6 carbon atoms, R¹³ represents an alkylene group having 2 to 12 carbon atoms or an arylene group having 6 to 12 carbon atoms, R¹⁴ to R²¹ each independently represent a hydrogen atom or an alkyl group having 1 to 6 carbon atoms, "y" and "z" each independently represent an integer of from 1 to 11, and "n" represents an integer of from 1 to 43.

IPC 8 full level

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